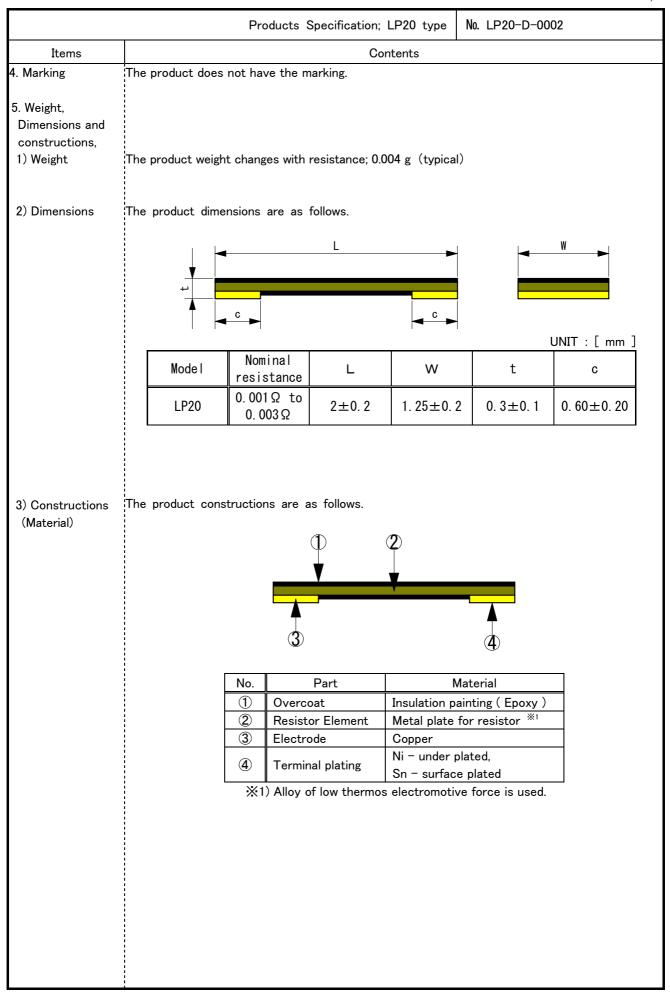
Specification No.	Rev. Symbol	Page		Distribution
LP20-D-0002		0/7		
	<u>DRAF</u>	Γ Specif	ication	<u>1</u>
				-
F	For CURREN	NT DETECTING MET	AL PLATE CHIP F	RESISTOR
Model		LP20		
HO]	KURIKU ELI	ECTRIC INI	OUSTRY CO	., LTD.
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Established Date		Revised Date	e	Applied Date

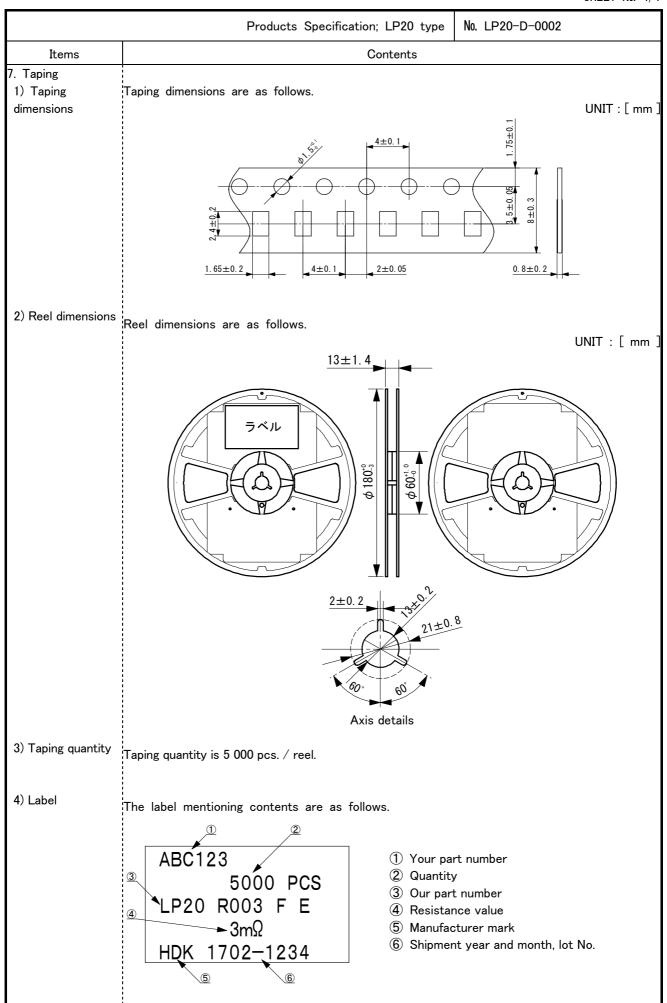
Drawn up by

Engineering Section

		SHEET No. 1/	
	Products Specification;	; LP20 type No. LP20-D-0002	
Items	Contents		
1. Application	This specification covers Current Detecting Metal Plate Chip Resistors; LP20 type.		
2. Model No. designation	Model No. is designated as follows.  Ex. LP20 R003 F E  Model Nominal Tolerance Taping type resistance (Paper taping)  Tolerance: Resistance tolerance is denoted by 1 alphabet capital letter.		
	(F → Resistance tolerance ±1.0 %)	y i alphabet capital letter.	
3. Ratings 1) Ratings	Ratings are shown Table-1.	−1. Ratings	
	Item	Contents	
	Nominal resistance	0.001 Ω to 0.003 Ω	
	Resistance tolerance	Class F(±1.0 %)	
	Temperature coefficient	±100 ppm/°C	
	Rated ambient temperature	70 °C	
	Operating temperature range	−55 °C to 150 °C	
	Rated wattage	0.5 W	
	Rated   Ood		
	0 <del>- − − − − − − − − − − − − − − − − − − </del>	70 150	
	·	temperature [ °C ] erating curve	
3) Rated voltage	Rated voltage is the D.C. or rms A.C. maximum voltage at ambient temperature from -55 °C 70 °C. Rated voltage shall be determined from following formula.		
	$E = \sqrt{(P \times R)}$ P:	Rated voltage $[\ V\ ]$ Rated wattage $[\ W\ ]$ Nominal resistance $[\ \Omega\ ]$	
4) Nominal resistance	Nominal resistance is in the range of 0.001 $\Omega$ to 0.003 $\Omega$		



		ı	Products Specification; L	P20 type	No. LP20-D-0002
Items	Contents				
6. Characteristics and Test method	Characteristics and test method are shown Table 2.  Table 2. Characteristics and Test method				
	No.	Items	Characteristics		Test method
	1	Resistance	Tolerance class F;	Measurei	ment current; 1 A
			within ±1.0 %	measure	d at 25 °C
	2	Temperature	within±100 ppm/°C	standard	temperature; 25 °C
		coefficient		measure	d temperature; 150 °C
		of resistance			
	3	Short-time	Resistance change;		ed electric power equal to 3 times
		overload	within ±0.5 %	-	ver in 5 s. 01−1 4.13
	4	Insulation	Over $10^9~\Omega$	Be meas	sured at terminals and center of
		resistance		resistor b	oy d.c.100 V±15 V in 1 min. 01-1 4.6
	5	Dielectric	Without breakdown	Be appli	ied at terminals and center of
		withstanding		resistor o	on a.c. 100V, 1min.
		voltage		JIS C 52	
	6	Resistance	Resistance change;		on the copper sheet (t=0.2 mm)
		to soldering	within ±0.5 %	heated by	
		heat	No remarkable outward damage		heet temperature; 260 °C $\pm$ 5 °C 5 s $\pm$ 0.5 s
	7	Solder-ability	Over 95 % coverage		rsed terminal in solder (Sn3Ag0.5Cu)
		Colder ability	Over 00 % ooverage		ture of solder; 245 °C±5 °C
					of immersion; 3 s±0.5 s
	!				01–1 4.17
	8	Vibration	Resistance change;	Vibration	frequency range; 10 Hz to 55 Hz
			within $\pm 0.5 \%$	Peak to	peak amplitude; 1.5 mm
			No remarkable		sweeping; 1 min.
			outward damage		direction each 2 h
		D	N	_	01-1 4.22
	9	Resistance	No remarkable		Isopropyl alcohol ture; 20 to 25 °C
		to solvent	outward damage		of immersion; 60 s±5 s
	10	High temp.	Resistance change;		ture; 150 °C±2 °C
		exposure	within ±2.0 %		; 0 % power.
				Duration;	
				JIS C 52	01-1 4.23.2
	11	Change of	Resistance change;		3 °C(30 min.)/normal temp. (2 to 3
		temperature	within ±0.5 %	-	50 °C $\pm$ 2 °C (30 min.)/normal
			No remarkable	temp.(2 t	
	10		outward damage		of cycles; 5 cycles
	12	Moisture	Resistance change;		ndition is MIL-STD-202, method
	1	resistance	within ±1.0 %		power 7a and 7b not required, 4 h, 10 cycles
	13	Bias humidity	Resistance change;		ture; 85 °C±2 °C.
			within ±1.0 %	-	humidity; 85 %.
					s load; on time 90 min./off time 30
				min.	
				Duration;	
	14	Endurance	Resistance change;	-	ture;70 °C±3 °C.
		(Rated load)	within ±2.0 %		attage; 90 min ON, 30 min OFF.
	<b> </b>			Duration;	1 000 h.
	į	<u>-</u>	<del></del>		



		Products Specific	cation; LP20 type	No. LP20-D-0002
Items	Contents			
8. Packaging	A reel is packaged in	the following box.		
	Number of reel	D(mm)	Dimension of packaging box(mm)	
	1	15		190
	2	27		
	3	40	\label	
	4	48		190   190   1abel

		SHEET No. 6/7	
	Products Specification; LP20 type	No. LP20-D-0002	
Items	Contents		
	Please avoid the corrosive circumstances like the Ammoniun kinds of gases erode the solder plating of electrodes to trou		
operation (inclusive	Soldering iron tip shall be slowly applied so as not to float the Tip temperature shall be below 310 $^{\circ}$ C, time be within 3 s. Iron tip application to the same point shall be 2 times. For noting to fresh one.	each.	
	As shown below, pre-heat shall be 140 to 180 $^{\circ}$ C, 60 to 120 255+/-5 $^{\circ}$ C, 5 s. maximum, the number of times within 2 tin		
	250 220 220 150 100 140 °C~180 °C 60 s~120 s 50 60 120 Time [ s ]	Peak temp. : 255+/-5 °C	
4) Positioning	The products shall be so laid out as to minimize the impact or deflection of the board when it is divided. The products shall not be installed in places close to the divided. Low-resistance resistors shall be used with care because the divided of the percent of that of the resistor.	viding line or prone to strains.	
trootmont	Resin burying, coating, and similar operations may change the material used. The material shall therefore be checked befor		
6) Thermal effect design	Please confirm thermal effects in using conditions because	resistor is heat-up part.	

		OHEET 140: 77 7		
	Products Specification; LP20 type	No. LP20-D-0002		
Items	Contents			
	It is guaranteed that the product will retain normal solder-ability for one year in the standard state as per JIS C $5201-1$ , clause $4.2$ (at temperatures between $15$ and $35$ °C and relative humidity between $25$ and $75$ %). It is not desirable that the Resistor are stored are at dusty, harmful gas, for example hydrogen chloride and sulfate gas etc.			
	Even if have use it in a derating curve, in consideration of self-fever, ambient temperature of a resistor, heat influence from the other parts. We ask for enough load deratings in case of use in a stable state for a long term.			
3) Shock to the Resistor	When the resistors are shocked, there is danger that the resistor breaks. So in use of surface mounter, please adjust it for no damaging to the resistor. Please avoid dropping in a high, too.			
4) RoHS directive	This resistor is a product satisfying a RoHS.			
5) For environmental protection	We don't use Class I ODC and PBBOs, PBBs in a products and the process.			
6) Off the subject of the restriction of export(COCOM)	This product is off the subject of the restriction of export (COCOM) like the strategic material etc.			
7) Cautions for Resistors	*This specification shows the quality and performance a adoption, please evaluate and check your product in whis This products are designed and manufactured for generalized equipment (AV equipment, household electric appliant and communication equipment, etc.). When there is a daserious damage will occur by the fault of this products as train, automobile, vessel, etc.), traffic signal, medical electric heating appliances, burning appliances, gas apparared prevention, and crime prevention equipment, please designately, such as the following.  * Systems with protective circuits and a protective expression with redundant circuits and others to do responsible.	ich the resistor was mounted. ral standard use in general electro nces, office equipment, information inger that a human life and other at transportation equipment (such equipment, aerospace equipment, ratus, rotation equipment, disaster gn fail—safe systems and ensure		
solder volume	This product is small and lightweight, so a product may float When a product floats on solder, a resistance becomes high The thickness of solder mask is recommended about 0.1 mr	t on solder in case of much solder. er than nominal resistance value.		